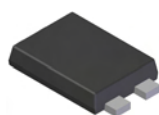


## Features

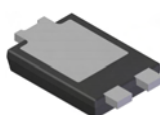
- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for 200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **“Green” Molding Compound (No Br, Sb)**

## Mechanical Data

- Case: POWERDI®5
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.093 grams (approximate)



Top View



Bottom View

LEFT PIN ○ RIGHT PIN ○ → BOTTOMSIDE HEAT SINK

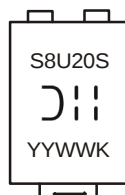
Note: Pins Left & Right must be electrically connected at the printed circuit board.

## Ordering Information (Note 2)

| Part Number   | Case      | Packaging        |
|---------------|-----------|------------------|
| SBR8U20SP5-13 | POWERDI®5 | 5000/Tape & Reel |

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*  
2. For packaging details, go to our website at <http://www.diodes.com>.

## Marking Information



S8U20S = Product Type Marking Code  
 = Manufacturers' Code Marking  
 K = Factory Designator  
 YYWW = Date Code Marking  
 YY = Last Two Digits of Year (ex: 08 for 2008)  
 WW = Week code (01 - 53)

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

| Characteristic                                                                                      | Symbol           | Value | Unit |
|-----------------------------------------------------------------------------------------------------|------------------|-------|------|
| Peak Repetitive Reverse Voltage                                                                     | V <sub>RRM</sub> | 20    | V    |
| Working Peak Reverse Voltage                                                                        | V <sub>RWM</sub> |       |      |
| DC Blocking Voltage                                                                                 | V <sub>RM</sub>  |       |      |
| Average Rectified Output Current                                                                    | I <sub>O</sub>   | 8     | A    |
| Non-Repetitive Peak Forward Surge Current 8.3ms<br>Single Half Sine-Wave Superimposed on Rated Load | I <sub>FSM</sub> | 180   | A    |

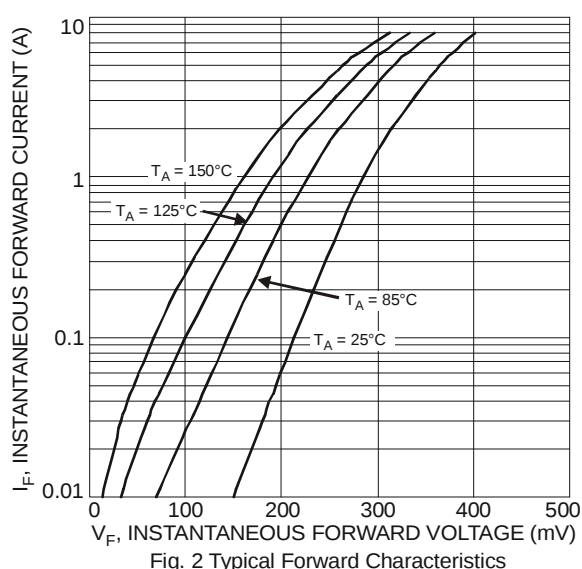
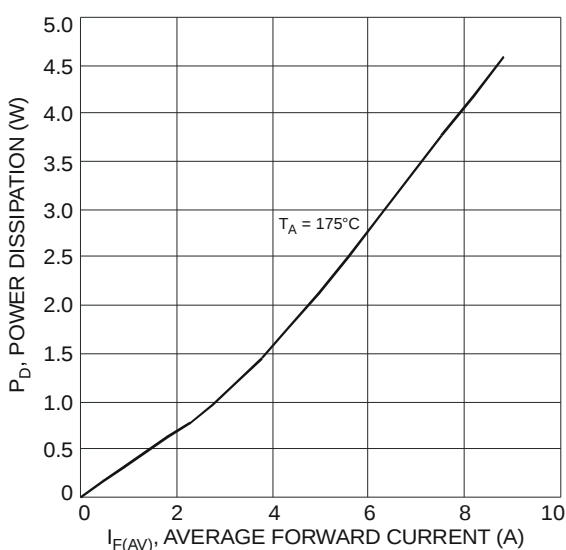
**Thermal Characteristics**

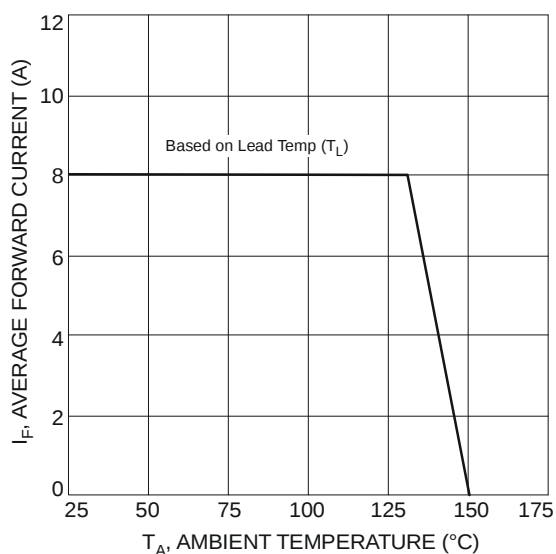
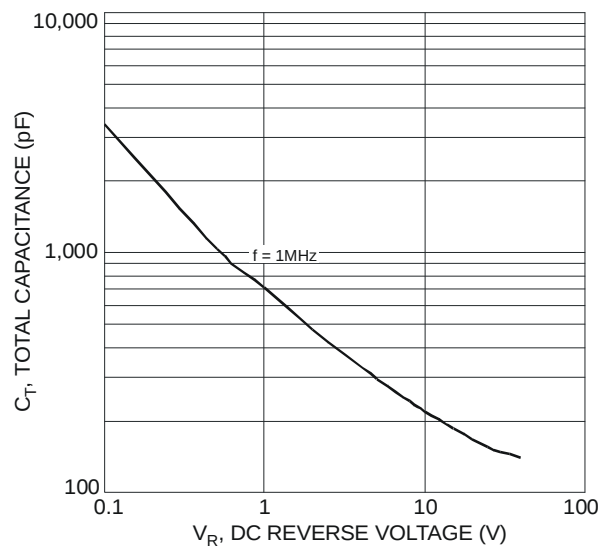
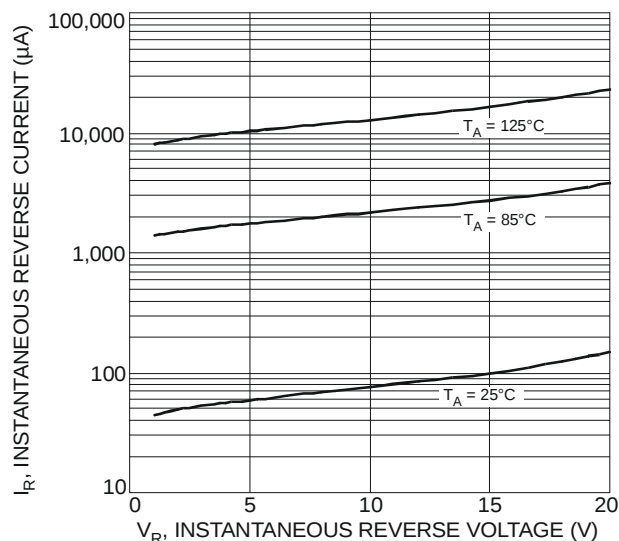
| Characteristic                                  | Symbol                                | Value       | Unit |
|-------------------------------------------------|---------------------------------------|-------------|------|
| Maximum Thermal Resistance                      | R <sub>θJA</sub>                      | 102         | °C/W |
| Thermal Resistance Junction to Ambient (Note 3) | R <sub>θJA</sub>                      | 60          |      |
| Thermal Resistance Junction to Ambient (Note 4) |                                       |             |      |
| Operating Temperature Range                     | V <sub>R</sub> ≤ 80% V <sub>RRM</sub> | -65 to +150 | °C   |
|                                                 | V <sub>R</sub> ≤ 50% V <sub>RRM</sub> | ≤180        |      |
|                                                 | DC Forward Mode                       | ≤200        |      |
| Storage Temperature Range                       | T <sub>STG</sub>                      | -65 to +175 | °C   |

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

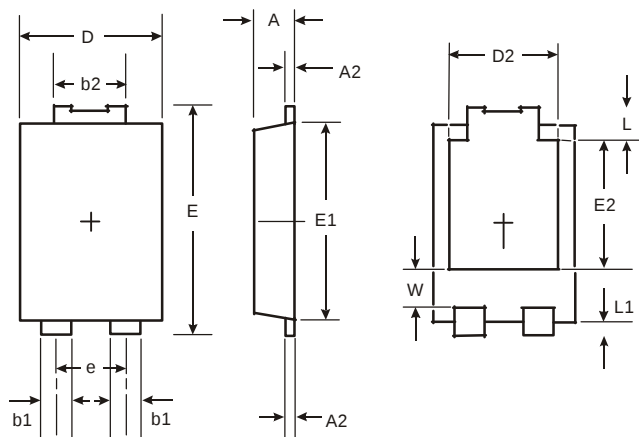
| Characteristic           | Symbol         | Min | Typ          | Max          | Unit | Test Condition                                                                            |
|--------------------------|----------------|-----|--------------|--------------|------|-------------------------------------------------------------------------------------------|
| Forward Voltage Drop     | V <sub>F</sub> | -   | 0.41<br>0.33 | 0.51<br>0.43 | V    | I <sub>F</sub> = 8A, T <sub>J</sub> = 25°C<br>I <sub>F</sub> = 8A, T <sub>J</sub> = 125°C |
| Leakage Current (Note 5) | I <sub>R</sub> | -   | 0.08<br>0.2  | 0.2<br>0.5   | mA   | V <sub>R</sub> = 4V, T <sub>J</sub> = 25°C<br>V <sub>R</sub> = 20V, T <sub>J</sub> = 25°C |

- Notes: 3. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.  
 4. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 14.4mm.  
 5. Short duration pulse test used to minimize self-heating effect.





## Package Outline Dimensions



| POWERDI <sup>®</sup> 5 |           |      |
|------------------------|-----------|------|
| Dim                    | Min       | Max  |
| A                      | 1.05      | 1.15 |
| A2                     | 0.33      | 0.43 |
| b1                     | 0.80      | 0.99 |
| b2                     | 1.70      | 1.88 |
| D                      | 3.90      | 4.05 |
| D2                     | 3.054 Typ |      |
| E                      | 6.40      | 6.60 |
| e                      | 1.84 Typ  |      |
| E1                     | 5.30      | 5.45 |
| E2                     | 3.549 Typ |      |
| L                      | 0.75      | 0.95 |
| L1                     | 0.50      | 0.65 |
| W                      | 1.10      | 1.41 |
| All Dimensions in mm   |           |      |

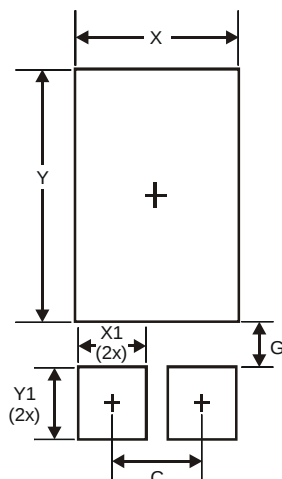
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## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.840         |
| G          | 0.852         |
| X          | 3.360         |
| X1         | 1.390         |
| Y          | 4.860         |
| Y1         | 1.400         |

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